



**Notification# # 20251103002.0  
Device Topside Marking Change for CC2340R21N0RGER Device  
Information Only**

**Date:** November 03, 2025  
**To:** MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the Change Management team.

Sincerely,

Change Management Team  
SC Business Services

**20251103002.0**  
**Information Only**  
**Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
CC2340R21N0RGER	NULL

Technical details of this Product Change follow on the next page(s).

<b>Notification Number:</b>	20251103002.0	<b>Notification Date:</b>	November 03, 2025		
<b>Title:</b>	Device Topside Marking Change for CC2340R21N0RGER Device				
<b>Customer Contact:</b>	Change Management team	<b>Dept:</b>	Quality Services		
<b>Change Type:</b>					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Materials
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

This notice is to communicate an update in topside marking for CC2340R21N0RGER device as follows:

	<b>Current</b>	<b>Proposed</b>
Topside marking	<ul style="list-style-type: none"> <li>○ CC2340</li> <li>R21</li> <li>TI XXX-</li> <li>XXXX G4</li> </ul>	<ul style="list-style-type: none"> <li>○ CC2340</li> <li>R21</li> <li>TI XXX<sup>N</sup></li> <li>XXXX G4</li> </ul>

#### Reason for Change:

Include die revision on package marking.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

#### Changes to product identification resulting from this notification:

None.

#### Product Affected:

CC2340R21N0RGER

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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